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Kind regards,

Team Nexperia



Product data sheet

1. Product profile

1.1 General description

Planar Schottky barrier diodes with an integrated guard ring for stress protection, encapsulated in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

1.2 Features and benefits

- Low forward voltage
- Low capacitance
- AEC-Q101 qualified

1.3 Applications

- Ultra high-speed switching
- Line termination

- Voltage clamping
- Reverse polarity protection

1.4 Quick reference data

Table 1. Quick reference data $T_{amb} = 25 \, ^{\circ}\!\! \text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
V_R	reverse voltage		-	-	30	V
V _F	forward voltage	$I_F = 100 \text{ mA}$	<u>[1]</u> _	600	-	mV
I_R	reverse current	$V_{R} = 25 \text{ V}$	<u>[1]</u> _	-	2	μΑ

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

2. Pinning information

Table 2. Pinning

Pin Description Simplified outline Graphic symbol

BAT754

1 anode
2 not connected
3 cathode



 Table 2.
 Pinning ...continued

Pin	Description	Simplified outline	Graphic symbol
BAT754A			
1	cathode (diode 1)		
2	cathode (diode 2)	3	3
3	common anode	1 2	1 2 006aaa439
BAT754C			
1	anode (diode 1)		2
2	anode (diode 2)	3	3
3	common cathode	1 2	12
BAT754S			
1	anode (diode 1)		
2	cathode (diode 2)	3	3
3	cathode (diode 1), anode (diode 2)	1 2	1 006aaa437

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BAT754 series	-	plastic surface-mounted package; 3 leads	SOT23		

4. Marking

Table 4. Marking codes

3	
Type number	Marking code ^[1]
BAT754	2K*
BAT754A	2L*
BAT754C	2M*
BAT754S	2N*

[1] * = placeholder for manufacturing site code.

5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

		• • •	,		
Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V_R	reverse voltage		-	30	V
I _F	forward current		-	200	mA
I _{FRM}	repetitive peak forward current	$t_p \leq \text{1 s; } \delta \leq 0.5$		300	mA
I _{FSM}	non-repetitive peak forward current	sine wave; t _p < 8.3 ms	<u>[1]</u> -	600	mA
Per device	; one diode loaded				
Tj	junction temperature		-	125	°C
T _{amb}	ambient temperature		-55	+125	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] $T_i = 25$ °C before surge.

6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per device;	one diode loaded					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	500	K/W

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

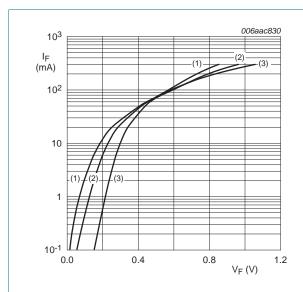
7. Characteristics

Table 7. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

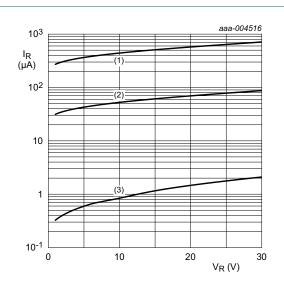
	Conditions	Min	Тур	Max	Unit
forward voltage		<u>[1]</u>			
	$I_F = 0.1 \text{ mA}$	-	-	200	mV
	I _F = 1 mA	-	-	260	mV
	I _F = 10 mA	-	-	340	mV
	I _F = 30 mA	-	-	420	mV
	I _F = 100 mA	-	600	-	mV
reverse current	V _R = 25 V	[1] -	-	2	μΑ
diode capacitance	$f = 1 MHz; V_R = 1 V$	-	-	10	pF
	everse current	$I_F = 0.1 \text{ mA}$ $I_F = 1 \text{ mA}$ $I_F = 10 \text{ mA}$ $I_F = 30 \text{ mA}$ $I_F = 100 \text{ mA}$ $V_R = 25 \text{ V}$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$	$\begin{array}{cccccccccccccccccccccccccccccccccccc$

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$



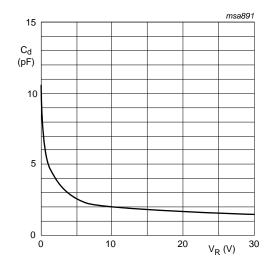
- (1) $T_{amb} = 125 \, ^{\circ}C$
- (2) $T_{amb} = 85 \, ^{\circ}C$
- (3) $T_{amb} = 25 \, ^{\circ}C$

Fig 1. Forward current as a function of forward voltage; typical values



- (1) $T_{amb} = 125 \, ^{\circ}C$
- (2) $T_{amb} = 85 \, ^{\circ}C$
- (3) $T_{amb} = 25 \, ^{\circ}C$

Fig 2. Reverse current as a function of reverse voltage; typical values



f = 1 MHz; T_{amb} = 25 °C

Fig 3. Diode capacitance as a function of reverse voltage; typical values

8. Test information

8.1 Quality information

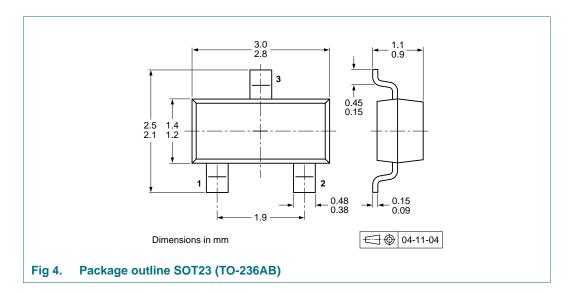
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

BAT754_SER

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9. Package outline



10. Packing information

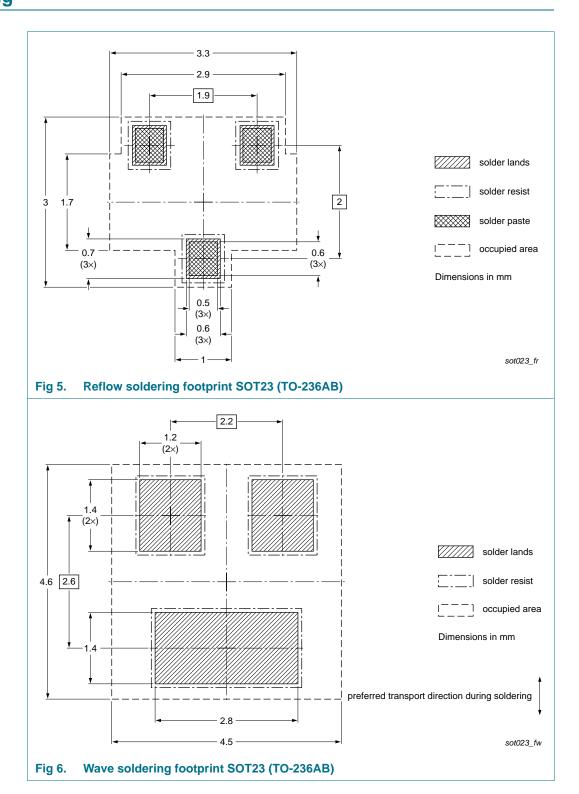
Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			3000	10000
BAT754 series	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see Section 14.

11. Soldering



12. Revision history

Table 9. Revision history

	•					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
BAT754_SER v.3	20121009	Product data sheet	-	BAT754_SERIES v.2		
Modifications:	 The format of this document has been redesigned to comply with the new ider guidelines of NXP Semiconductors. 					
 Legal texts have been adapted to the new company name where appropriate 				re appropriate.		
 <u>Section 1</u>: updated 						
 <u>Section 4</u>: updated 						
 <u>Table 5</u>: I_{FSM} conditions updated; changed T_{amb} minimum value to comply 				e to comply with AEC-Q101		
• Figure 1 and 2: updated						
	 Section 8 "Test information": added 					
	• Figure 4: re	placed by minimized packa	ge outline drawing			
	• Section 10	"Packing information": adde	ed			
	 Section 11 ° 	"Soldering": added				
	• Section 13	"Legal information": update	d			
BAT754_SERIES v.2	20030325	Product data sheet	-	BAT754_SERIES v.1		
BAT754_SERIES v.1	19990805	Product specification	-	-		

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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BAT754 series

Schottky barrier diodes

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BAT754 series

Schottky barrier diodes

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